506077790 05/27/2020

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
JOONHO LEE	05/27/2020
JOONSEOK LEE	05/27/2020
SOOAH CHO	05/27/2020

RECEIVING PARTY DATA

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Postal Code:	05510

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	16884696

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NAME OF SUBMITTER:	JONG H PARK
SIGNATURE:	/JONG H PARK/
DATE SIGNED:	05/27/2020

Total Attachments: 1

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PATENT REEL: 052768 FRAME: 0472

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Asterney Docket No. Q32220DH20

ASSIGNMENT

AS A BELOW NAMED INVENTOR, I, and each of us, individually hereby declare that: IN CONSIDERATION of the sum of TEN (\$10.00) dollars or the equivalent thereof, and other good and valuable consideration, the receipt of which from the hereinafter named Assignee is hereby acknowledged, I do hereby sell, assign and forever grant and convey unto:

SAMSUNG SDS CO., LTD.

having an address at (Sincheon-dong) 125, Olympic-ro 35-gil, Songpa-gu, Seoul 05510. Republic of Korea Who is my Assignee, and to the successors and assigns of my Assignee, all my digiti, title and interest, in and for the United States of America and all other countries, including all rights of priority, in and to the invention entitled:

METHOD FOR FEW-SHOT LEARNING AND APPARATUS FOR EXECUTING THE METHOD

invented by me and described in an application for a United States patent the specification of which is either attached hereto or otherwise accompanies this Assignment and in and to all United States patents which may be granted thereon and therefore, and in and to all certificates of corrections, divisions, continuations, continuations in part, reissued and re-examined patents, and to any extensions thereof, said interest being the entire awnership of the patent when granted to be held and enjoyed by SAMSUNG SDS CO., LTD., my Assignee, its auccessors, assigns or other legal representatives, to the full end of the term, terms, or any extension or renewal thereof, for which said patent or patents may be granted, as fully and entirely as the same would have been held and enjoyed by me or us if this assignment, sale and conveyance had not been made:

AND I hereby covenant and agree to sign and execute, without receiving any money or other consideration, any further documents or instruments which may from time to time be either necessary, lawfull, proper or requested by the Assignee, in the prosecution of the above-named application or in the preparation and prosecution of all substitute applications, certificate of correction, division, continuation, continuation inpart, reissue, re-examination, in any amendment, extension, or interference proceeding, whether administrative or judicial, or otherwise, to secure the title hereto in said Assignee, together with the right of priority under the international Convention for the Projection of Industrial Property, Inter-American Convention Relating to Patants. Designs and Industrial Models, and any other international agreement or treaty to which the United States of America adheres.

I hereby authorize and request the Patent Office Officials in the United States and its territorial possessions and any and all foreign countries to issue any and all of said Letters Patent, when granted, to said my Assignee.

IN WITNESS WHEREOF, I have set our hands and seals on the dates written beside my name:

Legal Name of First Inventor: LEE, JoonHo Inventor's Signature:		Date:	
	LEE, Jam Ho	May 21, 2020	
Legal Name of Additional Inventor: I	LEE, JoanSeok		
Inventor's Signature: COVA	· · · · · · · · · · · · · · · · · · ·	Date:	
Sunday	CEE, Join Geak	My 21, 2020	
Legal Name of Additional Inventor: t	CHO, SooAh		
Inventor's Signature:		Date:	
	Che seech	May 21. 2020	

RECORDED: 05/27/2020

PATENT

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